

## **PWM Step-Down Controller**

### **❖ GENERAL DESCRIPTION**

The AX3301 integrates Pulse-Width-Modulation (PWM) control circuit into a single chip. These device include a reference voltage source, oscillation circuit, error amplifier and etc.

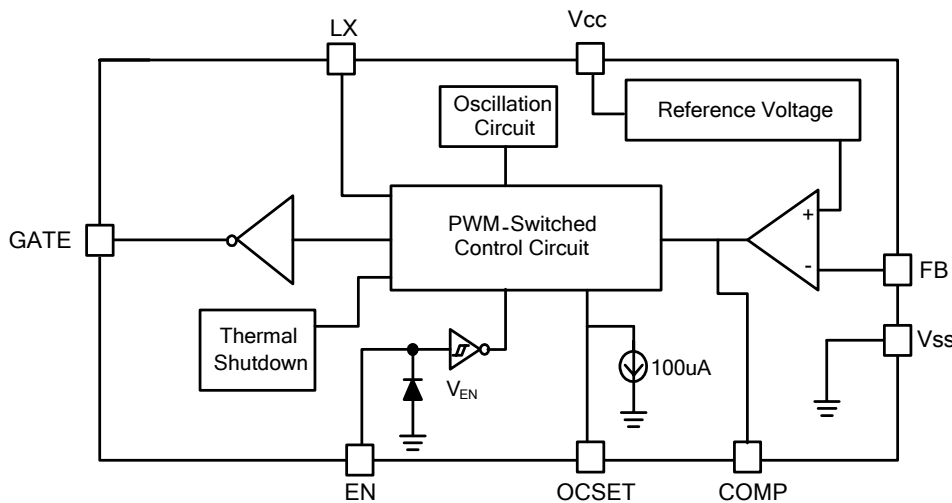
AX3301 provides low-ripple power, high efficiency, and excellent transient characteristics. The PWM control circuit is able to the duty ratio linearly form 0 up to 100%. An enable function, an over current protect function and short circuit protect function are built inside, and when OCP or SCP happens, the operation frequency will be reduced. Also, an external compensation can be system all used MLCC.

With the addition of an external P-channel Power MOS, a coil, capacitors, and a diode connected externally, these components can function as step-down switching regulators. They serve as ideal power supply units for portable devices when coupled with the SOP-8L & MSOP-8L mini-package, providing such outstanding features as low current consumption. Since this converter can accommodate an input voltage up to 24V, it is also suitable for the operation via an AC adapter.

### **❖ FEATURES**

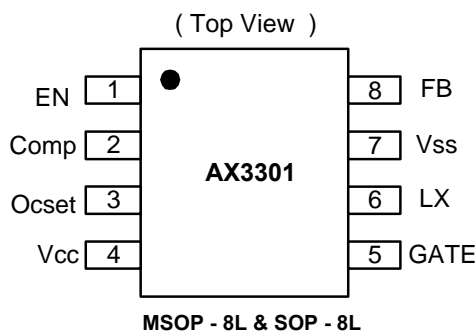
- Input voltage : 4V to 24V
- Output voltage : 0.8V to Vcc
- Duty ratio : 0% to 100% PWM control
- Oscillation frequency : 330KHz typ.
- Current Limit (CL), Enable function.
- Thermal Shutdown function.
- Short Circuit Protect (SCP).
- Low ESR output capacitor (Multi-layer chip capacitor (MLCC)) application.
- External SW P-channel MOS.
- MSOP-8L & SOP-8L Pb-Free package.

❖ **Block Diagram**



❖ **PIN ASSIGNMET**

These packages of AX3301 are MSOP-8L & SOP-8L; the pin assignment is given by:



Name	Description
EN	Shutdown Control Input. H : normal operation(Step-down) L : Shutdown mode
Comp	Compensation pin
OCSET	Add an external resistor to set max switch output current.
V <sub>CC</sub>	IC power supply pin
GATE	Gate drive for external P-channel MOSFET.
LX	LX is the current sense input.
V <sub>SS</sub>	GND pin
FB	Feedback pin

❖ **ORDER/MARKING INFORMATION**

Order Information	Top Marking
<p><b>AX3301 X X X</b></p> <p>Frequency      Package Type      Packing</p> <p>Blank : 330Khz    S : SOP-8L      Blank : Tube</p> <p>                          U : MSOP-8L    A : Taping</p>	<p>Logo ← <b>AX</b> 3301 → Part number</p> <p>    <b>X X X X X</b> → ID code: internal</p> <p>                          → WW: 01~52</p> <p>                          → Year: 06 = 2006</p>

❖ **Absolute Maximum Ratings** (at Ta=25°C)

Characteristics	Symbol	Rating	Unit
VCC Pin Voltage	V <sub>CC</sub>	V <sub>SS</sub> - 0.3 to V <sub>SS</sub> + 26	V
Feedback Pin Voltage	V <sub>FB</sub>	V <sub>SS</sub> - 0.3 to V <sub>CC</sub>	V
ON/OFF Pin Voltage	V <sub>EN</sub>	V <sub>SS</sub> - 0.3 to V <sub>CC</sub> + 0.3	V
Switch Pin Voltage	V <sub>SW</sub>	V <sub>SS</sub> - 0.3 to V <sub>CC</sub> + 0.3	V
Power Dissipation	PD	Internally limited	mW
Storage Temperature Range	T <sub>ST</sub>	-40 to +150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-20 to +125	°C
Operating Supply Voltage	V <sub>OP</sub>	+4 to +24	V
Thermal Resistance from Junction to case	θ <sub>JC</sub>	SOP8=40, MSOP8=45	°C/W
Thermal Resistance from Junction to ambient	θ <sub>JA</sub>	SOP8=120, MSOP8=200	°C/W

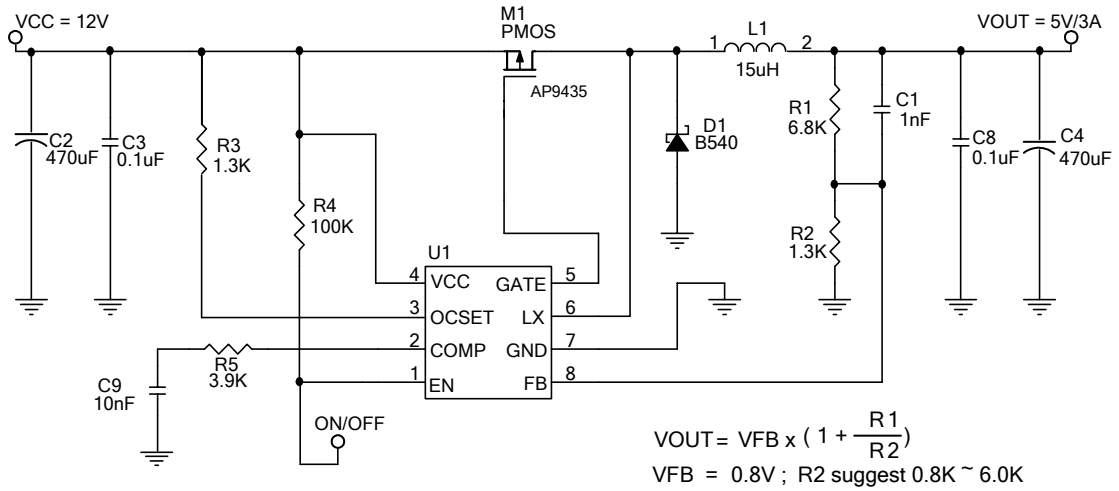
Note : θ<sub>JA</sub> is measured with the PCB copper area of approximately 1 in<sup>2</sup>(Multi-layer).

❖ **Electrical Characteristics** (V<sub>CC</sub> = 12V, Ta=25°C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min	Typ	Max	Units	
Feedback Voltage	V <sub>FB</sub>	I <sub>OUT</sub> =0.1A	0.784	0.800	0.816	V	
Quiescent Current	I <sub>CCQ</sub>	V <sub>FB</sub> =1.2V force driver off		3	5	mA	
Feedback Bias Current	I <sub>FB</sub>	I <sub>OUT</sub> =0.1A	-	0.1	0.5	uA	
Shutdown Supply Current	I <sub>SD</sub>	V <sub>EN</sub> =0V	-	2	10	uA	
OCSET pin bias current	I <sub>OCSET</sub>		95	110	125	uA	
Line Regulation	ΔV <sub>OUT</sub> /V <sub>OUT</sub>	V <sub>CC</sub> = 5V~24V, I <sub>OUT</sub> =0.2A	-	0.6	1.2	%	
Load Regulation	ΔV <sub>OUT</sub> /V <sub>OUT</sub>	I <sub>OUT</sub> = 0.1 to 3A	-	0.3	0.5	%	
Oscillation Frequency	F <sub>OSC</sub>	SW pin	260	330	400	KHz	
EN Pin Logic input threshold voltage	V <sub>SH</sub>	High (regulator ON)	2.0	-	-	V	
	V <sub>SL</sub>	Low (regulator OFF)	-	-	0.8		
EN Pin Input Current	I <sub>SH</sub>	V <sub>EN</sub> =2.5V (ON)	-	20	-	uA	
	I <sub>SL</sub>	V <sub>EN</sub> =0.3V (OFF)	-	-10	-	uA	
LX Rise Time	T <sub>LXR</sub>	C <sub>LX</sub> =1000pF		45		nS	
LX Fall Time	T <sub>LXF</sub>	C <sub>LX</sub> =1000pF		45			
Efficiency	EFFI	V <sub>OUT</sub> = 5V	I <sub>OUT</sub> = 2A	-	92	-	%
			I <sub>OUT</sub> = 3A	-	91	-	
Thermal shutdown Temp	TSD			125		°C	

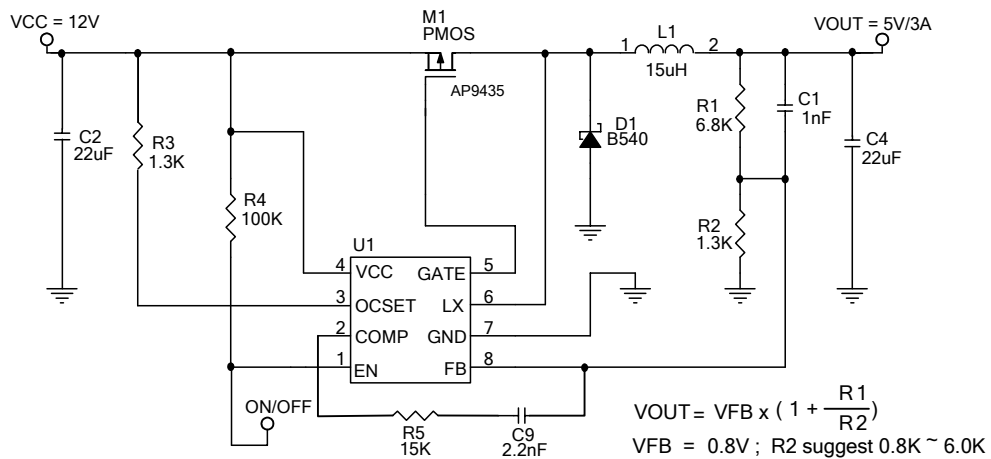
❖ **Application Circuit**

**A. AL CAP**



Compensation Capacitor Selection(AL CAP)				
V <sub>IN</sub>	V <sub>OUT</sub>	R5	C9	C1
5-16V	5/3.3/2.5/1.8V	3.9K	10nF	1nF

**B. MLCC**



Compensation Capacitor Selection(MLCC)				
V <sub>IN</sub>	V <sub>OUT</sub>	R5	C9	C1
12V	5.0/ 3.3/2.5V	15K	2200pF	1nF
12V	1.8V	10K	2200pF	1nF
5V	3.3/2.5/1.8V	15K	2200pF	1nF

❖ **Function Descriptions**

**PWM Control**

The AX3301 integrates Pulse-Width-Modulation (PWM) control circuit into a single chip. The pulse width varies in a range from 0 to 100%, according to the load current. The ripple voltage produced by the switching can easily be removed through a filter because the switching frequency remains constant. Therefore, these controllers provide a low-ripple power over broad ranges of input voltage and load current.

**RDS(ON) Current Limiting**

The current limit threshold is setting by the external resistor (R3) connecting from V<sub>CC</sub> supply to OCSET pin. The internal 110uA sink current crossing the resistor sets the voltage at pin of OCSET. When the PWM voltage is less than the voltage at OCSET, an over-current condition is triggered. Please refer to the formula for setting the current limit value

$$I_{SW(MAX)} = \frac{I_{OCSET} \times R3 + 0.075}{R_{DS(ON)}}$$

(Normally, The I<sub>SW(MAX)</sub> setting more than I<sub>OUT</sub> 0.5~1.0A).

Example:

$$I_{SW} = (110\mu A * 1.3k + 0.075) / 50m\Omega \text{ (AP9435GM SPEC)} = 4.36A$$

**Setting the Output Voltage**

Application circuit item shows the basic application circuit with AX3301 adjustable output version. The external resistor sets the output voltage according to the following equation:

$$V_{OUT} = 0.8V \times \left( 1 + \frac{R1}{R2} \right)$$

Table 1 Resistor select for output voltage setting

V <sub>OUT</sub>	R2	R1
5V	1.3K	6.8K
	5.6K	30K
3.3V	1.5K	4.7K
	5.6K	18K
2.5V	2.2K	4.7K
	5.6K	12K
1.8V	1.2K	1.5K
1.5V	2.2K	2.0K

### Inductor Selection

For most designs, Low inductance values are physically smaller but require faster switching, which results in some efficiency loss. The inductor value can be derived from the following equation:

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{LX}}$$

Where is inductor Ripple Current. Large value inductors lower ripple current and small value inductors result in high ripple currents. Choose inductor ripple current approximately 15% of the maximum input current 3A,  $\Delta I_L = 0.45A$ .

Table 2 Inductor select for output voltage setting (AX3301 at  $V_{CC} = 12V$ )

$V_{OUT}$	2.5V	3.3V	5V	3.3V(5A)	5V(5A)
L1 Value	15uH	18uH	22uH	12uH	15uH

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation ( $3A + 0.3A$ ).

### Input Capacitor Selection

#### (EL CAP)

This capacitor should be located close to the IC using short leads and the voltage rating should be approximately 1.5 times the maximum input voltage. The RMS current rating requirement for the input capacitor of a buck regulator is approximately 1/2 the DC load current. A low ESR input capacitor sized for maximum RMS current must be used. A 220μF low ESR capacitor for most applications is sufficient.

#### (MLCC CAP)

A 22μF MLCC capacitor for most applications is sufficient.

### Output Capacitor Selection

#### (EL CAP)

The output capacitor is required to filter the output and provide regulator loop stability. The important capacitor parameters are; the 100KHz Equivalent Series Resistance (ESR), the RMS ripples current rating, voltage rating, and capacitance value. For the output capacitor, the ESR value is the most important parameter. The ESR can be calculated from the following formula.

$$V_{RIPPLE} = \Delta I_L \times ESR = 0.4A \times 110m\Omega = 44mV$$

An aluminum electrolytic capacitor's ESR value is related to the capacitance and its voltage rating. In most case, higher voltage electrolytic capacitors have lower ESR values. Most of the time, capacitors with much higher voltage ratings may be needed to provide the low ESR values required for low output ripple voltage. It is recommended to replace this low ESR capacitor by using a 330 $\mu$ F low ESR values < 110m $\Omega$ .

#### (MLCC CAP)

A 22 $\mu$ F MLCC capacitor for most applications is sufficient.

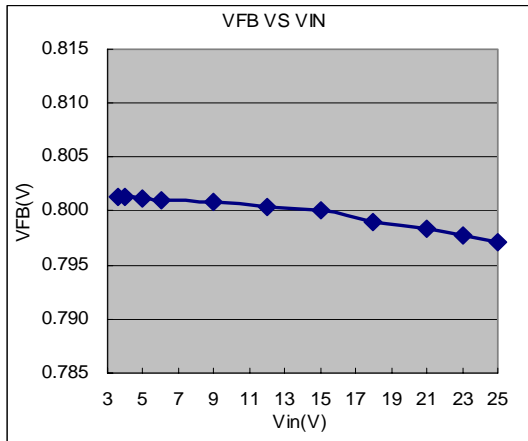
#### Layout Guidance

When laying out the PC board, the following suggestions should be taken to ensure proper operation of the AX3301. These items are also illustrated graphically in below.

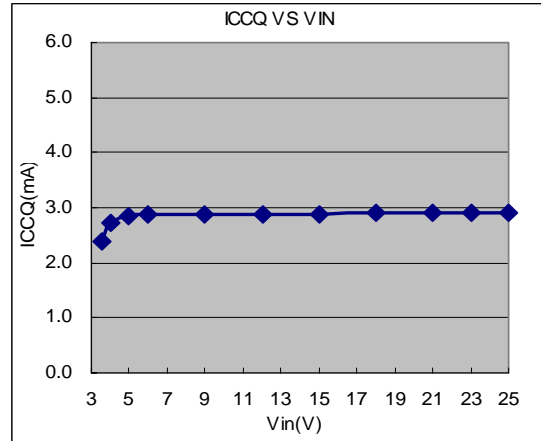
1. The power traces, including the PMOS Drain & Source trace, the Schottky and the C2 trace should be kept short, direct and wide to allow large current flow.
2. Keep the switching node, away from the sensitive FB node.
3. Connect ground side of the C2 & D1 as closely as possible.
4. Connect PMOS Source and R3 as closely as possible.
5. Do not trace signal line under inductor.

❖ Typical Characteristics

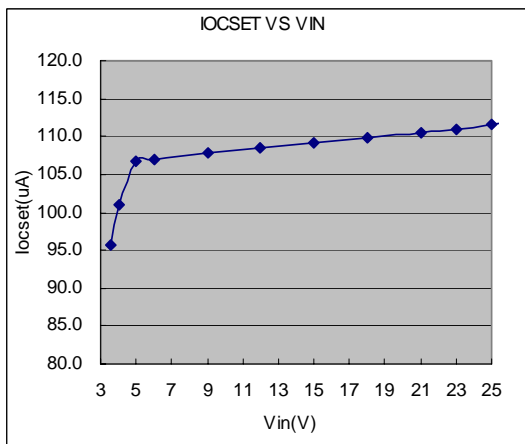
**VFB VS VIN**



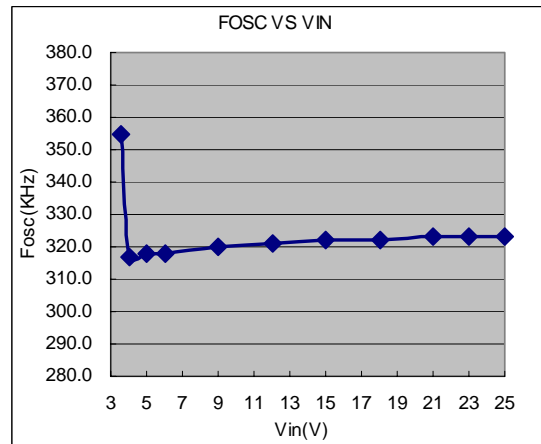
**ICCQ VS VIN**



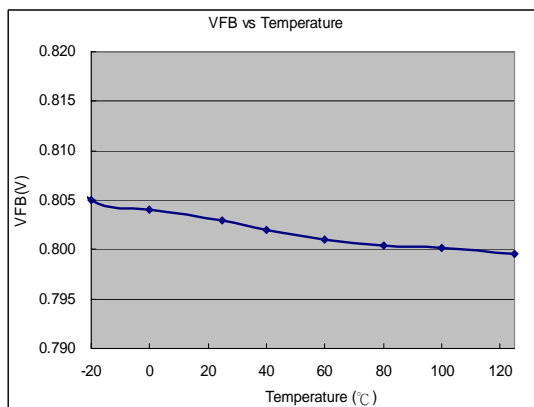
**IOCSET VS VIN**



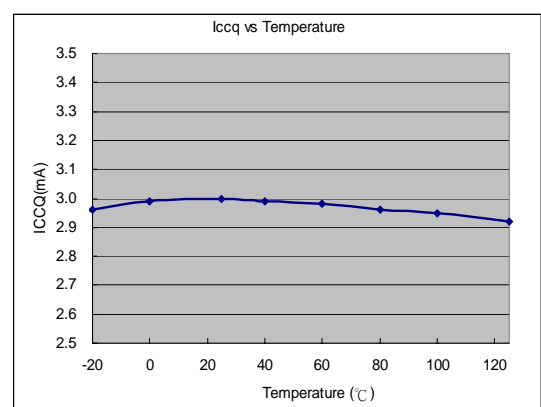
**FOSC VS VIN**



**VFB VS TEMPERATURE**



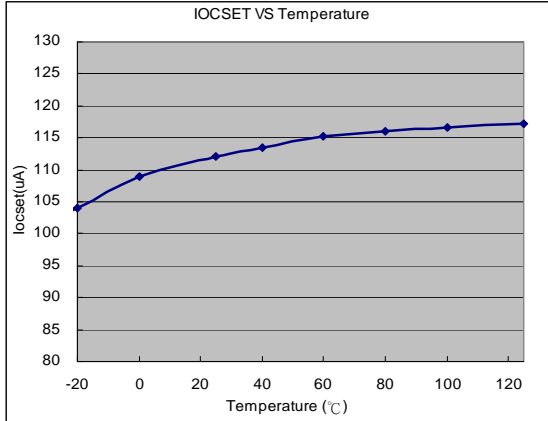
**ICCQ VS TEMPERATURE**



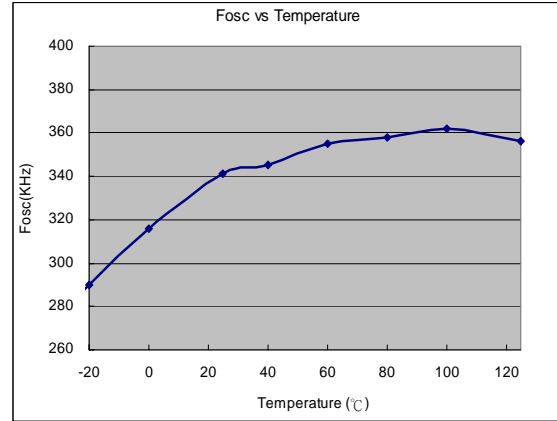


❖ Typical Characteristics

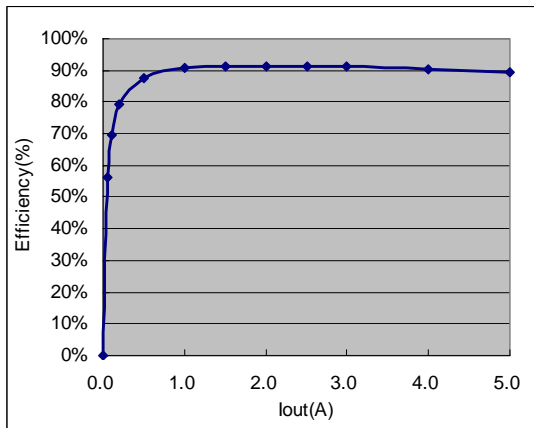
**IOCSET VS TEMPERATURE**



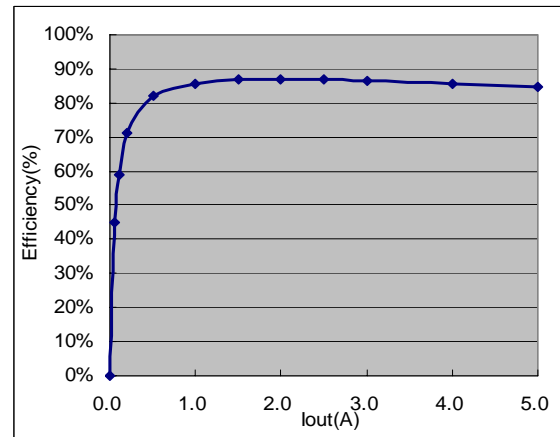
**FOSC VS TEMPERATURE**



**Efficiency**  
**(V<sub>IN</sub>=12V, V<sub>OUT</sub>=5V)**



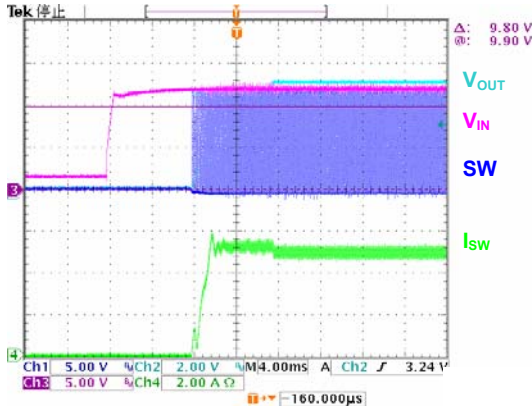
**Efficiency**  
**(V<sub>IN</sub>=12V, V<sub>OUT</sub>=3.3V)**



❖ **Typical Characteristics (Typical circuit )**

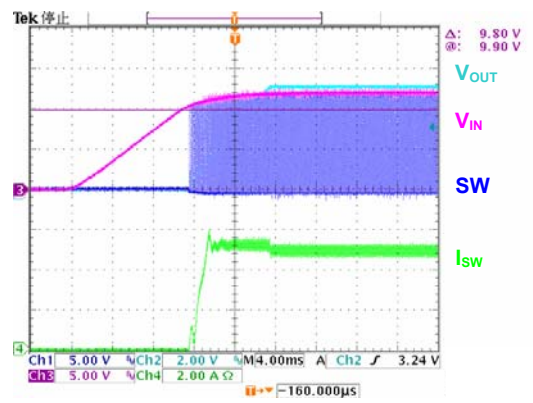
**EN PIN on test wave**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{OUT}=5A$ )



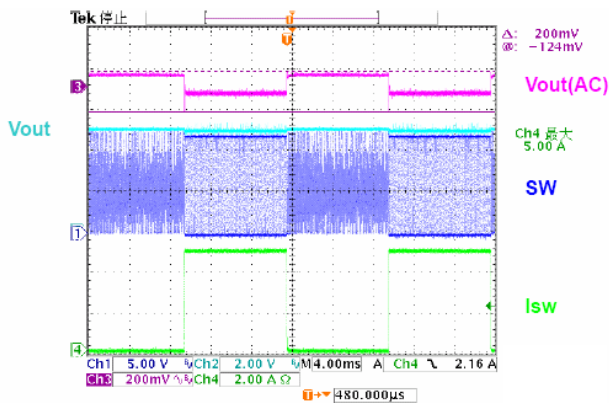
**Power on test wave**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{OUT}=5A$ )



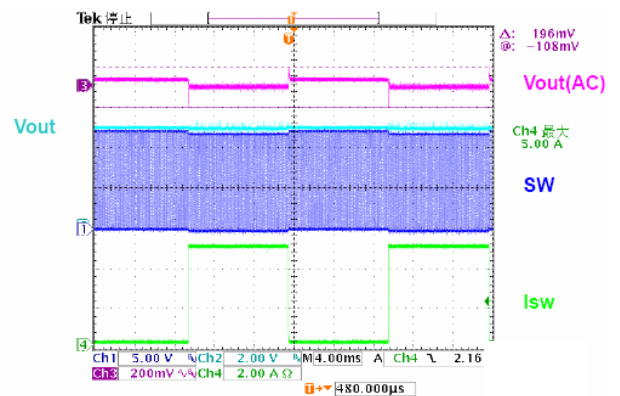
**Load transient Response 0A to 5A**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ )



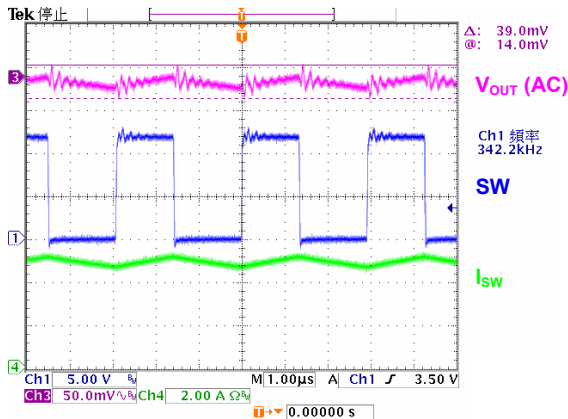
**Load transient Response 0.2A to 5A**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ )



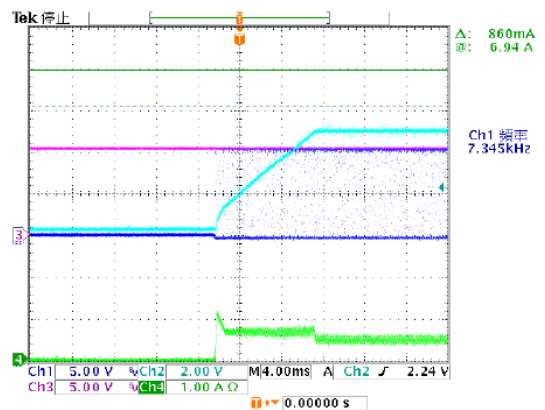
**Output Ripple**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{OUT}=5A$ )

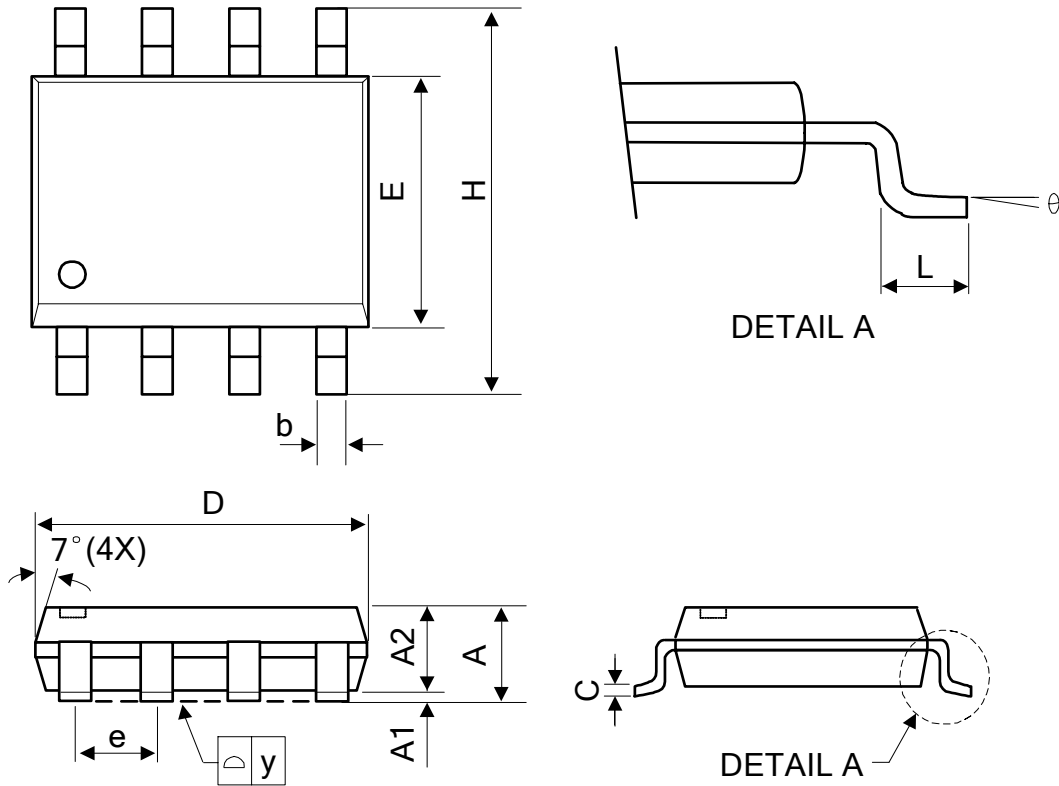


**Start-Up from Thermal Shutdown**

( $V_{IN}=12V$ ,  $V_{OUT}=5V$ ,  $I_{OUT}=1A$ )

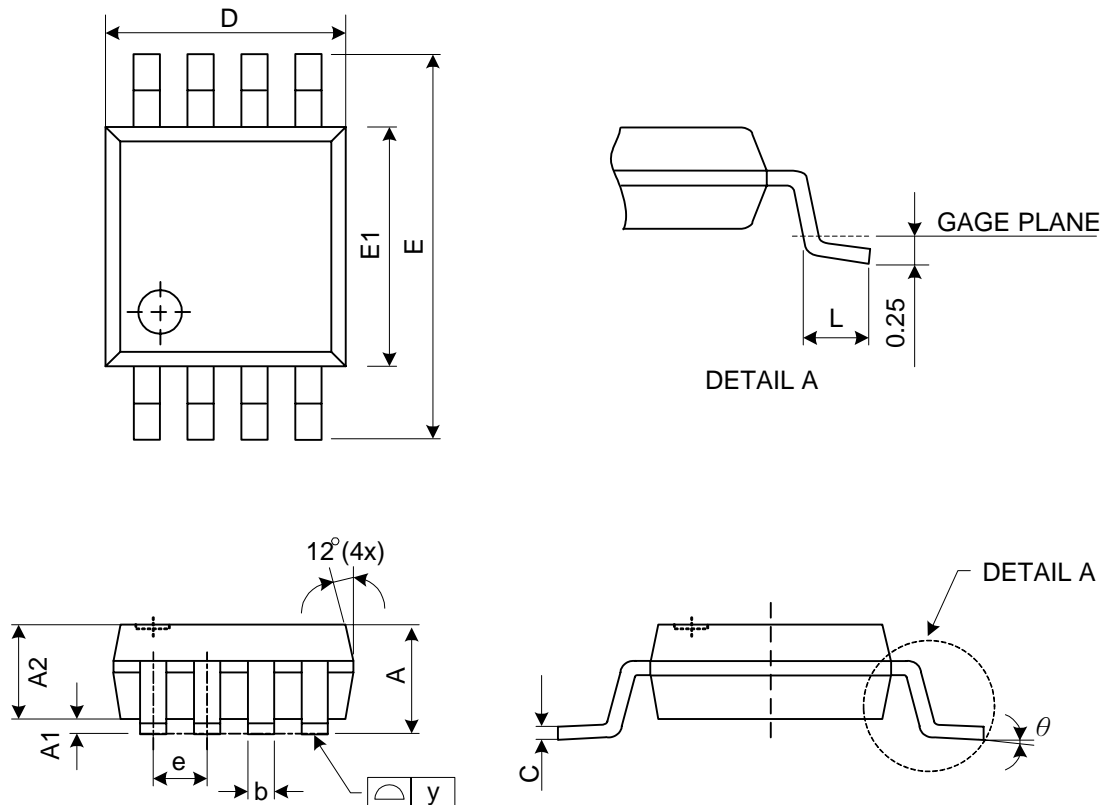


❖ Package Outlines (SOP-8L)



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.40	1.60	1.75	0.055	0.063	0.069
A1	0.10	-	0.25	0.040	-	0.100
A2	1.30	1.45	1.50	0.051	0.057	0.059
C	0.19	0.20	0.25	0.0075	0.008	0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E	3.80	3.90	4.00	0.150	0.154	0.157
H	5.79	5.99	6.20	0.228	0.236	0.244
L	0.38	0.71	1.27	0.015	0.028	0.050
b	0.33	0.41	0.51	0.013	0.016	0.020
e	1.27 TYP			0.050 TYP		
y	-	-	0.10	-	-	0.004
θ	0°	-	8°	0°	-	8°

❖ Package Outlines (MSOP-8L)



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.81	0.96	1.12	0.032	0.038	0.044
A1	0.05	-	0.15	0.002	-	0.006
A2	0.76	0.86	0.97	0.030	0.034	0.038
b	0.28	0.30	0.38	0.011	0.012	0.015
C	0.13	0.15	0.23	0.005	0.006	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.80	4.90	5.00	0.189	0.193	0.197
E1	2.90	3.00	3.10	0.114	0.118	0.122
e	-	0.65	-	-	0.0256	-
L	0.40	0.6	0.8	0.016	0.023	0.032
y	-	-	0.076	-	-	0.003
θ	0°	3°	6°	0°	3°	6°